

September 1983 Revised February 1999

# MM74HC373 3-STATE Octal D-Type Latch

## **General Description**

The MM74HC373 high speed octal D-type latches utilize advanced silicon-gate CMOS technology. They possess the high noise immunity and low power consumption of standard CMOS integrated circuits, as well as the ability to drive 15 LS-TTL loads. Due to the large output drive capability and the 3-STATE feature, these devices are ideally suited for interfacing with bus lines in a bus organized system

When the LATCH ENABLE input is HIGH, the Q outputs will follow the D inputs. When the LATCH ENABLE goes LOW, data at the D inputs will be retained at the outputs until LATCH ENABLE returns HIGH again. When a high logic level is applied to the OUTPUT CONTROL input, all outputs go to a high impedance state, regardless of what

signals are present at the other inputs and the state of the storage elements.

The 74HC logic family is speed, function, and pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to  $V_{CC}$  and ground.

### **Features**

- Typical propagation delay: 18 ns
- Wide operating voltage range: 2 to 6 volts
- Low input current: 1 µA maximum
- Low quiescent current: 80 µA maximum (74 Series)
- Output drive capability: 15 LS-TTL loads

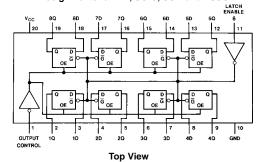
## **Ordering Code:**

Order Number	Package Number	Package Description
MM74HC373WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
MM74HC373SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC373MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC373N	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### **Connection Diagram**

### Pin Assignments for DIP, SOIC, SOP and TSSOP



### **Truth Table**

ſ	Output	Latch	Data	373
	Control	Enable		Output
Ī	L	Н	Н	Н
	L	Н	L	L
	L	L	X	$Q_0$
	Н	Х	Х	Z

- H = HIGH Level
- L = LOW Level
- $\mathbf{Q}_0 = \mathbf{Level}$  of output before steady-state input conditions were established.
- Z = High Impedance

## **Absolute Maximum Ratings**(Note 1)

(Note 2)

Supply Voltage (V <sub>CC</sub> )	-0.5 to +7.0V
DC Input Voltage (V <sub>IN</sub> )	$-1.5$ to $V_{CC}$ +1.5V
DC Output Voltage (V <sub>OUT</sub> )	$-0.5$ to $V_{CC}$ +0.5V
Clamp Diode Current (I <sub>IK</sub> , I <sub>OK</sub> )	±20 mA
DC Output Current, per pin (I <sub>OUT</sub> )	±35 mA
DC $V_{CC}$ or GND Current, per pin ( $I_{CC}$ )	±70 mA
Storage Temperature Range (T <sub>STG</sub> )	-65°C to +150°C
Power Dissipation (P <sub>D</sub> )	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T <sub>L</sub> )	
(Soldering 10 seconds)	260°C

# Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V <sub>CC</sub> )	2	6	V
DC Input or Output Voltage			
$(V_{IN}, V_{OUT})$	0	$V_{CC}$	V
Operating Temperature Range (T <sub>A</sub> )	-40	+85	°C
Input Rise or Fall Times			
$(t_r, t_f) V_{CC} = 2.0V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: –
12 mW/°C from 65°C to 85°C.

## **DC Electrical Characteristics**

Symbol		Conditions	V <sub>CC</sub>	T <sub>A</sub> = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$	T <sub>A</sub> = -55 to 125°C	Units
Symbol	Parameter	Conditions	VCC	Тур		Guaranteed Limits		Units
$V_{IH}$	Minimum HIGH Level		2.0V		1.5	1.5	1.5	٧
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V <sub>IL</sub>	Maximum LOW Level		2.0V		0.5	0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V <sub>OH</sub>	Minimum HIGH Level	$V_{IN} = V_{IH}$ or $V_{IL}$						
	Output Voltage	$ I_{OUT}  \le 20 \mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or $V_{IL}$						
		$ I_{OUT}  \le 6.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT}  \le 7.8 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V <sub>OL</sub>	Maximum LOW Level	$V_{IN} = V_{IH}$ or $V_{IL}$						
	Output Voltage	$ I_{OUT}  \le 20 \ \mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or $V_{IL}$						
		$ I_{OUT}  \le 6.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT}  \le 7.8 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I <sub>IN</sub>	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μА
	Current							
l <sub>OZ</sub>	Maximum 3-STATE	$V_{IN} = V_{IH}$ or $V_{IL}$ , $OC = V_{IH}$	6.0V		±0.5	±5	±10	μΑ
	Output Leakage	$V_{OUT} = V_{CC}$ or GND						
	Current							
I <sub>CC</sub>	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND	6.0V		8.0	80	160	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$						

Note 4: For a power supply of 5V  $\pm$ 10% the worst case output voltages ( $V_{OH}$ , and  $V_{OL}$ ) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case  $V_{IH}$  and  $V_{IL}$  occur at  $V_{CC} = 5.5V$  and 4.5V respectively. (The  $V_{IH}$  value at 5.5V is 3.85V.) The worst case leakage current ( $I_{IN}$ ,  $I_{CC}$ , and  $I_{OZ}$ ) occur for CMOS at the higher voltage and so the 6.0V values should be used.

## **AC Electrical Characteristics**

 $V_{CC} = 5V$ ,  $T_A = 25^{\circ}C$ ,  $t_r = t_f = 6$  ns

Symbol	Parameter	Conditions	18 25 21 30		Units
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay, Data to Q	C <sub>L</sub> = 45 pF	18	25	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay, LE to Q	C <sub>L</sub> = 45 pF	21	30	ns
t <sub>PZH</sub> , t <sub>PZL</sub>	Maximum Output Enable Time	$R_L = 1 \text{ k}\Omega$ $C_L = 45 \text{ pF}$	20	28	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Maximum Output Disable Time	$R_L = 1 \text{ k}\Omega$ $C_L = 5 \text{ pF}$	18	25	ns
t <sub>S</sub>	Minimum Set Up Time			5	ns
t <sub>H</sub>	Minimum Hold Time			10	ns
t <sub>W</sub>	Minimum Pulse Width		9	16	ns

## **AC Electrical Characteristics**

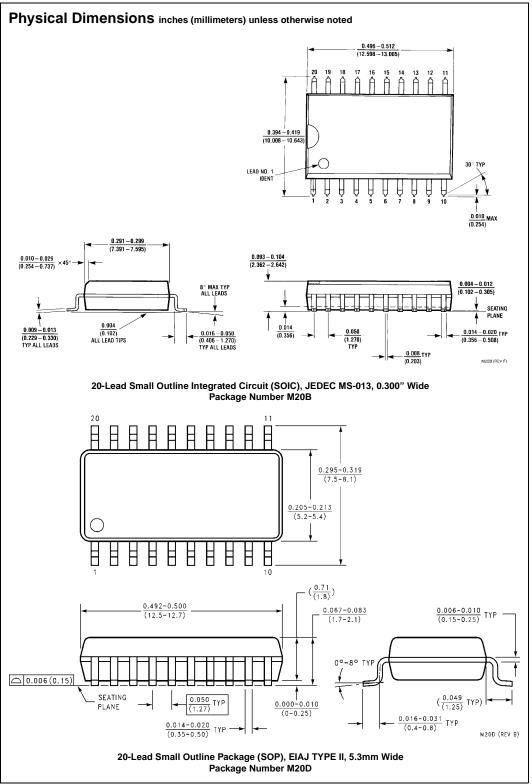
 $\rm V_{CC}$  = 2.0–6.0V,  $\rm C_L$  = 50 pF,  $\rm t_f$  =  $\rm t_f$  = 6 ns (unless otherwise specified)

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$ $T_A = -55 \text{ to } 125^{\circ}\text{C}$		Units
			• CC	Тур		Guaranteed L	imits	Onne
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation	C <sub>L</sub> = 50 pF	2.0V	50	150	188	225	ns
	Delay, Data to Q	$C_L = 150 \text{ pF}$	2.0V	80	200	250	300	ns
		$C_L = 50 \text{ pF}$	4.5V	22	30	37	45	ns
		$C_L = 150 pF$	4.5V	30	40	50	60	ns
		C <sub>L</sub> = 50 pF	6.0V	19	26	31	39	ns
		$C_L = 150 pF$	6.0V	26	35	44	53	ns
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation	C <sub>L</sub> = 50 pF	2.0V	63	175	220	263	ns
	Delay, LE to Q	$C_L = 150 pF$	2.0V	110	225	280	338	ns
		C <sub>L</sub> = 50 pF	4.5V	25	35	44	52	ns
		C <sub>L</sub> = 150 pF	4.5V	35	45	56	68	ns
		C <sub>L</sub> = 50 pF	6.0V	21	30	37	45	ns
		C <sub>L</sub> = 150 pF	6.0V	28	39	49	59	ns
t <sub>PZH</sub> , t <sub>PZL</sub>	Maximum Output	$R_L = 1 k\Omega$						
	Enable Time	C <sub>L</sub> = 50 pF	2.0V	50	150	188	225	ns
		C <sub>L</sub> = 150 pF	2.0V	80	200	250	300	ns
		C <sub>L</sub> = 50 pF	4.5V	21	30	37	45	ns
		C <sub>L</sub> = 150 pF	4.5V	30	40	50	60	ns
		C <sub>L</sub> = 50 pF	6.0V	19	26	31	39	ns
		C <sub>L</sub> = 150 pF	6.0V	26	35	44	53	ns
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Maximum Output Disable	$R_L = 1 k\Omega$	2.0V	50	150	188	225	ns
	Disable Time	$C_{L} = 50 \text{ pF}$	4.5V	21	30	37	45	ns
			6.0V	19	26	31	39	ns
t <sub>S</sub>	Minimum Set Up Time		2.0V		50	60	75	ns
			4.5V		9	13	15	ns
			6.0V		9	11	13	ns
t <sub>H</sub>	Minimum Hold Time		2.0V		5	5	5	ns
			4.5V		5	5	5	ns
			6.0V		5	5	5	ns
t <sub>W</sub>	Minimum Pulse Width		2.0V	30	80	100	120	ns
			4.5V	10	16	20	24	ns
			6.0V	9	14	18	20	ns
t <sub>THL</sub> , t <sub>TLH</sub>	Maximum Output Rise	C <sub>L</sub> = 50 pF	2.0V	25	60	75	90	ns
	and Fall Time		4.5V	7	12	15	18	ns
			6.0V	6	10	13	15	ns
C <sub>PD</sub>	Power Dissipation	(per latch)						1
	Capacitance (Note 5)	$OC = V_{CC}$		30				pF
	, , ,	OC = GND		50				pF
C <sub>IN</sub>	Maximum Input Capacitance			5	10	10	10	pF

# AC Electrical Characteristics (Continued)

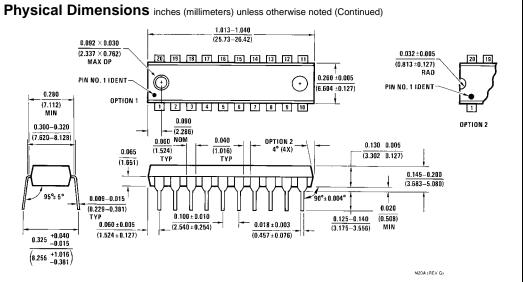
Symbol	Parameter	Conditions	v <sub>cc</sub>	T <sub>A</sub> = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$ $T_A = -55 \text{ to } 125^{\circ}\text{C}$ Guaranteed Limits		Units
- Cyzc.	T di di ilioto.			Тур				
C <sub>OUT</sub>	Maximum Output			15	20	20	20	pF
	Capacitance							

Note 5:  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$ .



## Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 6.5±0.1 -A--0.20 20 7.72 4.16 6,4 4.4±0.1 -B-32 PIN #1 IDENT. LAND PATTERN RECOMMENDATION SEE DETAIL A -0.90+0.15 0.09-0.20 0.1±0.05 0.65 -12.00° R0.09mir GAGE PLANE DIMENSIONS ARE IN MILLIMETERS 0.25 SEATING PLANE NOTES: A. CONFORMS TO JEDEC REGISTRATION MID-153, VARIATION AC, REF NOTE 6, DATE $7/93.\,$ -0.6±0.1--R0.09mln B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS. DETAIL A D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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